

**PATENT ASSIGNMENT**

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
Name	Execution Date
H.C. PRAVEENA	03/24/2010
<b>RECEIVING PARTY DATA</b>	
Name:	STMICROELECTRONICS Pvt. Ltd.
Street Address:	Plot No. 1, Knowledge Park III
City:	Greater Noida
State/Country:	INDIA
Postal Code:	201308
<b>PROPERTY NUMBERS Total: 1</b>	
Property Type	Number
Application Number:	12732604
<b>CORRESPONDENCE DATA</b>	
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Correspondent Name:	Carol W. Burton
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Address Line 4:	Denver, COLORADO 80202
ATTORNEY DOCKET NUMBER:	09-IND-213
NAME OF SUBMITTER:	Carol W. Burton
Total Attachments: 2 source=192040044ASSIGN#page1.tif source=192040044ASSIGN#page2.tif	

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**ASSIGNMENT**

WHEREAS, I, H.C. PRAVEENA, having a business address of Plot No. 1, Knowledge Park III, Greater Noida - 201308, UP, INDIA, have made a certain new and useful invention relating to MULTI-SUPPLY VOLTAGE COMPATIBLE I/O RING, for which an application for Letters Patent of the United States is to be filed, said application being identified by Docket No. 09-IND-213 and Client/Matter No. 19204.0044 in the law firm of Hogan & Hartson LLP, 1200 Seventeenth Street, Suite 1500, Denver, Colorado 80202, and which is executed concurrently herewith; and

WHEREAS, STMicronics Pvt. Ltd. whose address is Plot No. 1, Knowledge Park III, Greater Noida - 201308, UP, INDIA, ("ASSIGNEE") is desirous of acquiring my entire interest in and to said invention, said application, and the Letters Patent to be obtained therefor.

NOW THEREFORE, for certain good and valuable consideration to me in hand paid, the receipt and sufficiency of which are hereby acknowledged, I have sold, assigned, and set over, and by these presents do hereby sell, assign, and set over, to said ASSIGNEE, and said ASSIGNEE's legal representatives, successors, and assigns, my entire right, title, and interest in and to said invention, said application, all continuing applications, reissued and reexamined patents, and the Letters Patent, both foreign and domestic, that may or shall issue thereon; and I do hereby authorize and request the Commissioner of Patents and Trademarks to issue said Letters Patent to said ASSIGNEE, consistent with the terms of this Assignment.

UPON SAID CONSIDERATION, I do hereby covenant and agree with said ASSIGNEE that I will not execute any writing or do any act whatsoever conflicting with these presents, and that I will, at any time upon request, without further or additional consideration, but at the expense of said ASSIGNEE, execute such additional assignments and other writings and do such additional acts as said ASSIGNEE may deem necessary or desirable to perfect the ASSIGNEE's enjoyment of this grant, and

render all necessary assistance in making application for and obtaining original, continuing divisional, renewal, reissued or extended Letters Patent of the United States, or of any and all foreign countries, on said invention, and in enforcing any rights or choices in action occurring as a result of such applications or patents, by giving testimony in any proceedings or transactions involving such applications or patents, and by executing preliminary statements and other affidavits, it being understood and the foregoing covenant and agreement shall bind, and inure to the benefit of, the assigns and legal representatives of all parties.

IN WITNESS WHEREOF, I hereby state I have read the foregoing Assignment and have hereunto set my hand on the date hereinafter set forth.

Date: 24-03-2010

H.C. PRAVEENA  
H.C. PRAVEENA